

USB 3.0, 4:1 Mux/DeMux Switch

#### **Features**

→ 2 Differential Channel, 4:1 Mux/DeMux

→ USB 3.0 performance, 5.0 Gbps

→ Low Bit-to-Bit Skew, 7ps Max.

→ Low Crosstalk: -23dB@3GHz

→ Low Off Isolation: -23dB@3GHz

ightarrow V<sub>DD</sub> Operating Range: +1.8V+/-10%

→ ESD Tolerance 2kV HBM on data I/O

→ Packaging (Pb-free & Green):

- 42 contact TQFN

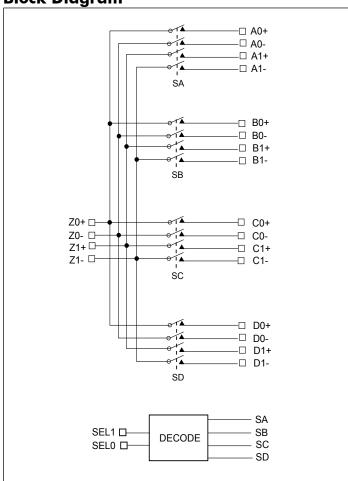
# **Description**

Diodes' PI2USB4122 is a 4 to 1 differential channel multiplexer/demultiplexer switch. Due to its low bit-to-bit skew, high channel-to-channel noise isolation and high bandwidth, this product is ideal for USB 3.0 switching to 5.0 Gbps.

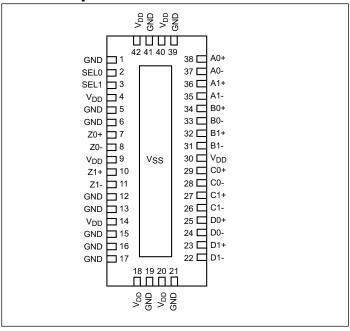
# **Application**

Switching USB 3.0 signals for Mux or DeMux.

# **Block Diagram**



## **Pin Description**



### **Truth Table**

SEL1	SEL0	FUNCTION
0	0	Z to A
0	1	Z to B
1	0	Z to C
1	1	Z to D

1





# **Maximum Ratings**

(Above which useful life may be impaired. For user guidelines, not tested.)

	orage Temperature	
	pply Voltage to Ground Potential	
DC	C Input Voltage C Output Current	0.5V to +V <sub>DD</sub>
DC	C Output Current	120mA
Po	wer Dissipation	0.5W

**Note:** Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

**Power Supply Characteristics** 

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units
$I_{CC}$	Quiescent Power Supply Current	$V_{DD} = Max$ , $V_{IN} = GND$ or $V_{DD}$		200	300	μΑ

#### Notes:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V<sub>DD</sub> = 1.8V, T<sub>A</sub> = 25°C ambient and maximum loading.

# DC Electrical Characteristics for Switching over Operating Range

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C, V_{DD} = 1.8V + /-10\%)$ 

Parameter	Description	<b>Test Conditions</b>	Min.	Typ. <sup>(2)</sup>	Max.	Units
$V_{\mathrm{IH}}$	Input HIGH Voltage	Guaranteed HIGH level	0.65 x V <sub>DD</sub>	-	-	
$V_{\mathrm{IL}}$	Input LOW Voltage	Guaranteed LOW level	-	1	0.35 x V <sub>DD</sub>	V
V <sub>IK</sub>	Clamp Diode Voltage	$V_{DD} = Max., I_{IN} = -18mA$	-	-0.7	-1.2	
$I_{IH}$	Input HIGH Current	$V_{DD} = Max., V_{IN} = V_{DD}$	-	-	±5	4
$I_{\mathrm{IL}}$	Input LOW Current	$V_{DD} = Max., V_{IN} = GND$	-	-	±5	μΑ

# Switching Characteristics (TA= $-40^{\circ}$ to $+85^{\circ}$ C, VDD = 1.8V+/-10%)

Parameter	Description	Min.	Typ.(2)	Max.	Units
tpzh, tpzl	Line Enable Time - SEL to A <sub>N</sub> , B <sub>N</sub>	0.5	-	8.0	na
tphz, tplz	Line Disable Time - SEL to A <sub>N</sub> , B <sub>N</sub>	0.5	-	10	ns
t <sub>b-b</sub>	Bit-to-bit skew within the same differential pair		7		ps
tch-ch	Channel-to-channel skew		35		ps

#### Notes:

# **Dynamic Electrical Characteristics Over the Operating Range**

 $(TA = -40^{\circ} \text{ to } +85^{\circ}\text{C}, VDD = 1.8V + /-10\%)$ 

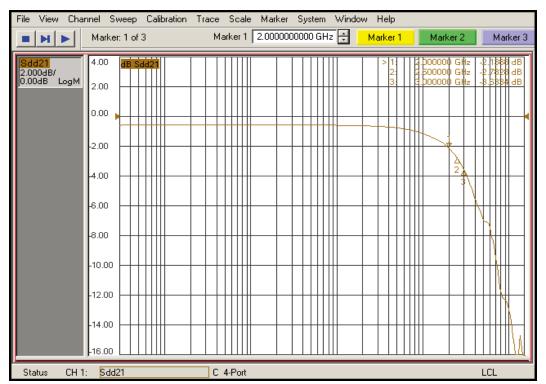
Parameter	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units
$X_{TALK}$	Crosstalk	f = 2.5 GHz		-40		dB
O <sub>IRR</sub>	OFF Isolation	f = 2.5 GHz		-25		dB
$I_{LOSS}$	Differential Insertion Loss	f= 2.5 GHz		-3.0		dB
BW	Bandwidth -3dB			2.6		GHz

#### Notes:

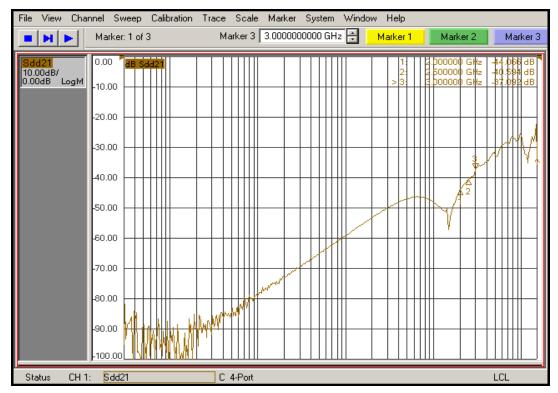
- Guaranteed by design.
- 2. Typical values are at  $V_{DD} = 1.8V$ ,  $T_A = 25^{\circ}C$  ambient and maximum loading.

<sup>1.</sup> For max. or min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.





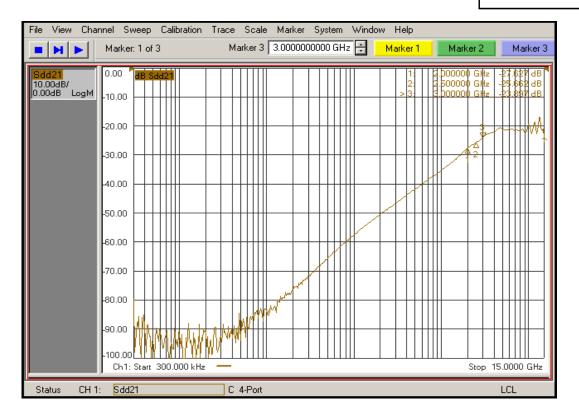
**Insertion Loss** 



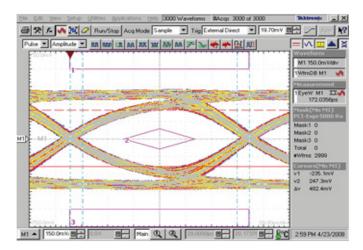
Crosstalk



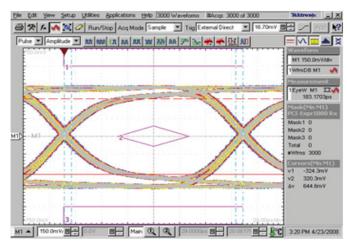




**Off Isolation** 



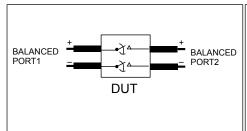
Signal Eye with Switch

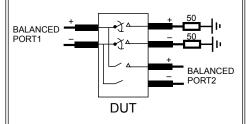


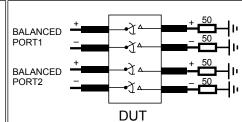
Signal Eye without Switch









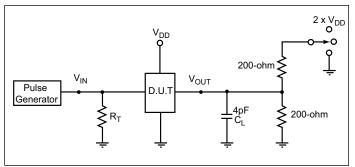


Diff. Insertion Loss and Return Test Circuit

**Diff. Off Isolation Test Circuit** 

Diff. Near End Xtalk Test Circuit

# Test Circuit for Electrical Characteristics(1-5)



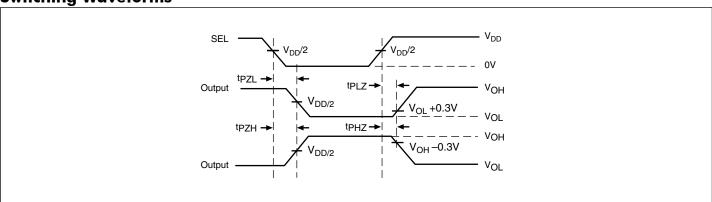
#### Notes:

- 1. C<sub>L</sub> = Load capacitance: includes jig and probe capacitance.
- 2.  $R_T$  = Termination resistance: should be equal to  $Z_{OUT}$  of the Pulse Generator
- 3. Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. All input impulses are supplied by generators having the following characteristics: PRR  $\leq$  MHz,  $Z_O = 50\Omega$ ,  $t_R \leq$  2.5ns,  $t_F \leq$  2.5ns.
- 5. The outputs are measured one at a time with one transition per measurement.

### **Switch Positions**

Test	Switch
t <sub>PLZ</sub> , t <sub>PZL</sub>	$2 \times V_{DD}$
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND
Prop Delay	Open

# **Switching Waveforms**

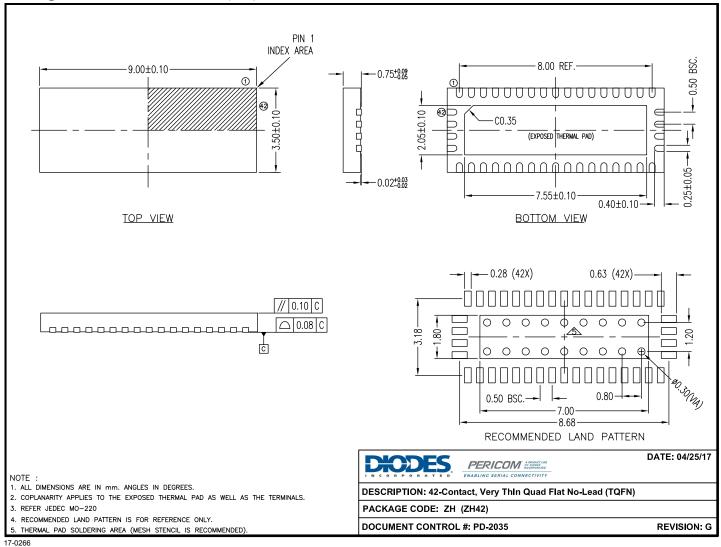


**Voltage Waveforms Enable and Disable Times** 





# Package Mechanical: 42-TQFN (ZH)



17-0266

### For latest package info.

 $please\ check:\ http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/packaging-mechanical-and-thermal-characteristics/packaging-mech$ 

# **Ordering Information**

Ordering Code	Package Code	Package Type
PI2USB4122ZHEX	ZH	42-Contact, Very Thin Quad Flat No-Lead (TQFN)

#### Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel





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